
2SC2732

Silicon NPN Epitaxial

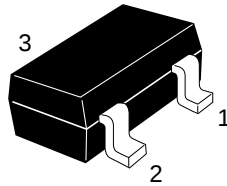
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Application

UHF frequency converter

Outline

MPAK



- 1. Emitter
- 2. Base
- 3. Collector

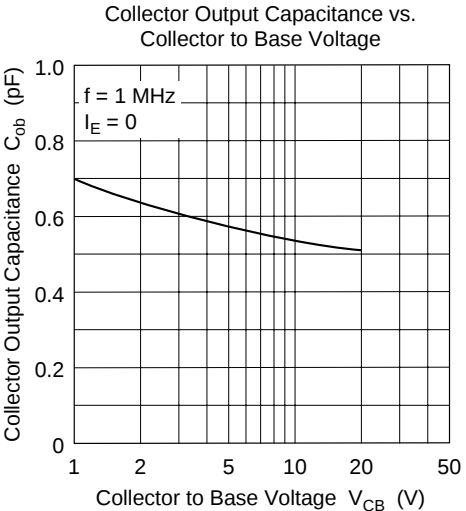
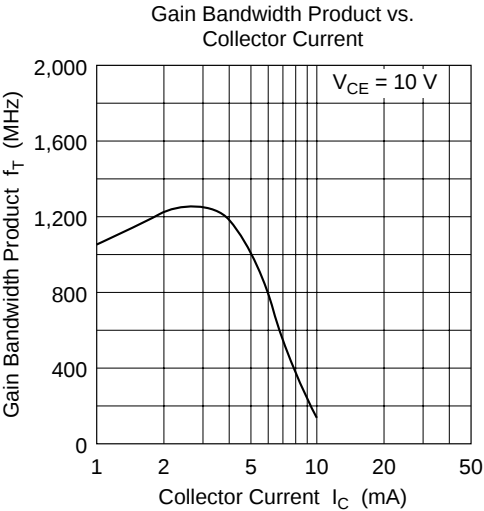
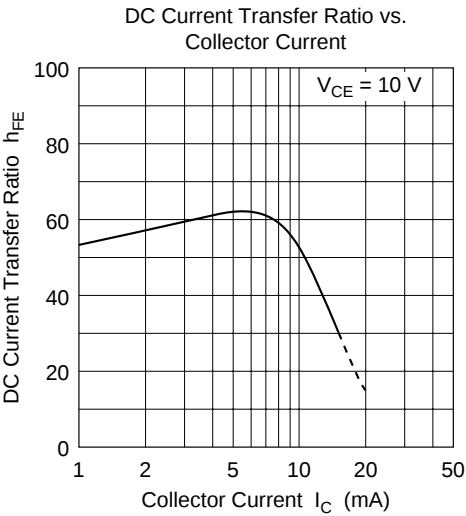
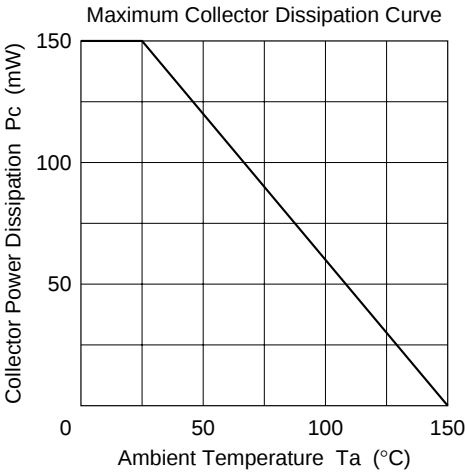
Absolute Maximum Ratings (Ta = 25°C)

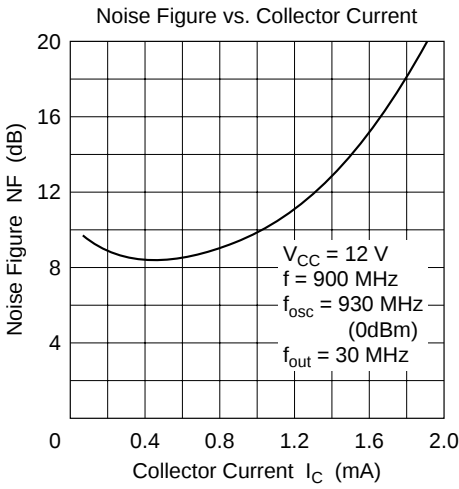
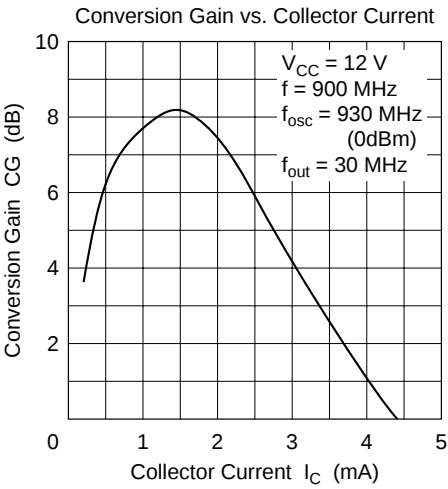
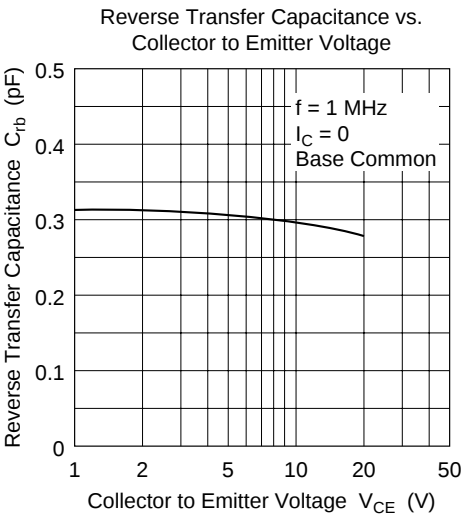
Item	Symbol	Ratings	Unit
Collector to base voltage	V_{CBO}	30	V
Collector to emitter voltage	V_{CEO}	25	V
Emitter to base voltage	V_{EBO}	4	V
Collector current	I_C	20	mA
Collector power dissipation	P_C	150	mW
Junction temperature	T_j	150	°C
Storage temperature	T_{stg}	-55 to +150	°C

Electrical Characteristics (Ta = 25°C)

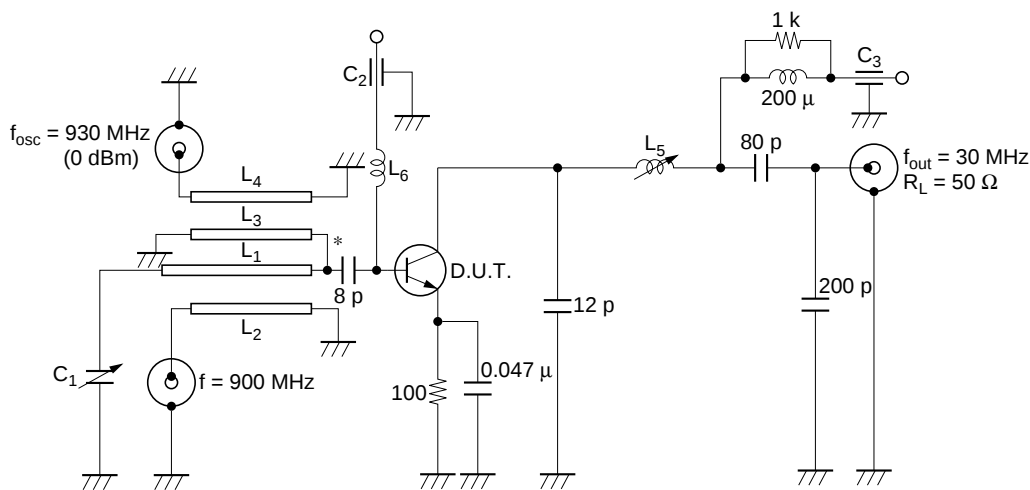
Item	Symbol	Min	Typ	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	30	—	—	V	$I_C = 10\text{ }\mu\text{A}$, $I_E = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	25	—	—	V	$I_C = 1\text{ mA}$, $R_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	4	—	—	V	$I_E = 10\text{ }\mu\text{A}$, $I_C = 0$
Collector cutoff current	I_{CBO}	—	—	0.5	μA	$V_{CB} = 10\text{ V}$, $I_C = 0$
Collector to emitter saturation voltage	$V_{CE(sat)}$	—	—	5	V	$I_C = 10\text{ mA}$, $I_B = 1\text{ mA}$
DC current transfer ratio	h_{FE}	30	60	—		$V_{CE} = 10\text{ V}$, $I_C = 3\text{ mA}$
Gain bandwidth product	f_T	700	1000	—	MHz	$V_{CE} = 10\text{ V}$, $I_C = 5\text{ mA}$
Collector output capacitance	C_{ob}	—	0.5	0.8	pF	$V_{CB} = 10\text{ V}$, $I_E = 0$, $f = 1\text{ MHz}$
Conversion gain	CG	—	7.0	—	dB	$V_{CC} = 12\text{ V}$, $I_C = 1\text{ mA}$, $f = 900\text{ MHz}$, $f_{OSC} = 930\text{ MHz (0dBm)}$, $f_{out} = 30\text{ MHz}$
Noise figure	NF	—	10.0	—	dB	$V_{CC} = 12\text{ V}$, $I_C = 1\text{ mA}$, $f = 900\text{ MHz}$, $f_{OSC} = 930\text{ MHz (0dBm)}$, $f_{out} = 30\text{ MHz}$

Note: Marking is “EC”.





Conversion Gain, Noise Figure Test Curcuit



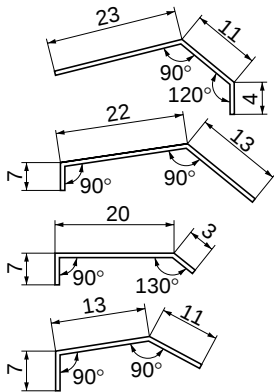
*.....Disk Capacitor
Unit R : Ω
C : F
L : H

L₁ : φ1 mm Enameled Copper wire

L₂ : φ1 mm Enameled Copper wire

L₃ : φ1 mm Enameled Copper wire

L₄ : φ1 mm Enameled Copper wire



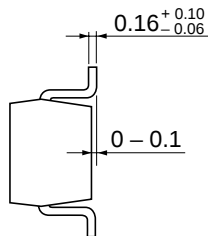
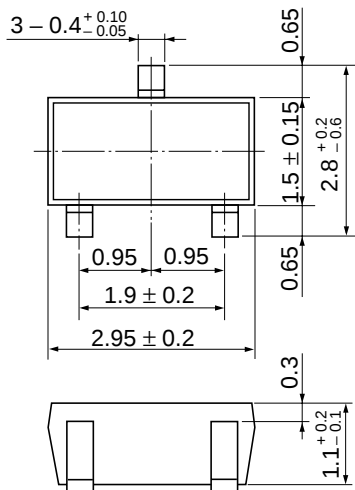
Unit : mm

L₅ : Bobbin φ0.5 mm inside dia, φ0.2 mm Enameled Copper wire 20 Turns

L₆ : φ5 mm Enameled Copper wire 1 Turns inside dia φ6 mm

C₁ : 20 pF max. Air Trimmer Condenser

C₂, C₃ : 1000 pF Air Core Capacitor



Hitachi Code	MPAK
JEDEC	—
EIAJ	Conforms
Weight (reference value)	0.011 g

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